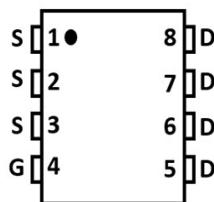
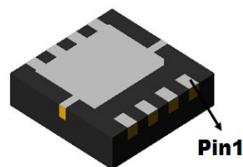
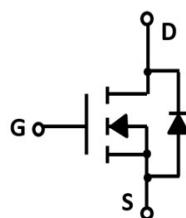




N-Channel Enhancement Mode Field Effect Transistor

**DFN3.3X3.3**

Product Summary

- V_{DS} 40 V
- I_D 20 A
- $R_{DS(ON)}$ (at $V_{GS} = 10V$) $< 14.0 \text{ mohm}$
- $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) $< 18.5 \text{ mohm}$
- 100% UIS Tested
- 100% ∇V_{DS} Tested

General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	40	V
Gate-source Voltage		V_{GS}	± 20	V
Drain Current	$T_c=25^\circ\text{C}$	I_D	20	A
	$T_c=100^\circ\text{C}$		14	
Pulsed Drain Current ^A		I_{DM}	90	A
Single Pulse Avalanche Energy ^B		E_{AS}	70	mJ
Total Power Dissipation	$T_c=25^\circ\text{C}$	P_D	21	W
	$T_A=25^\circ\text{C}$		2.34	
Thermal Resistance Junction-to-Case		$R_{\theta JC}$	5.9	$^\circ\text{C}/\text{W}$
		$R_{\theta JA}$	53.4	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	°C

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJQ20N04A	F1	Q20N04	5000	10000	100000	13" reel



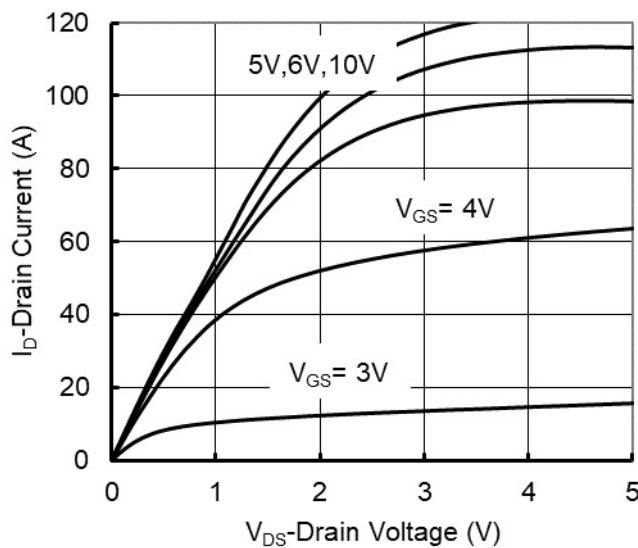
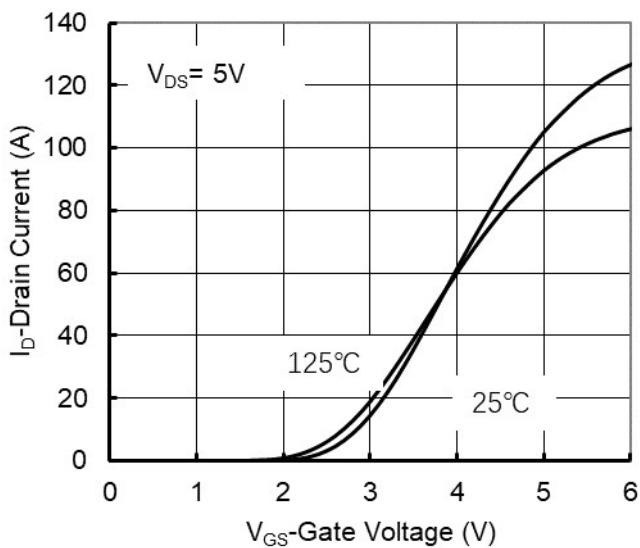
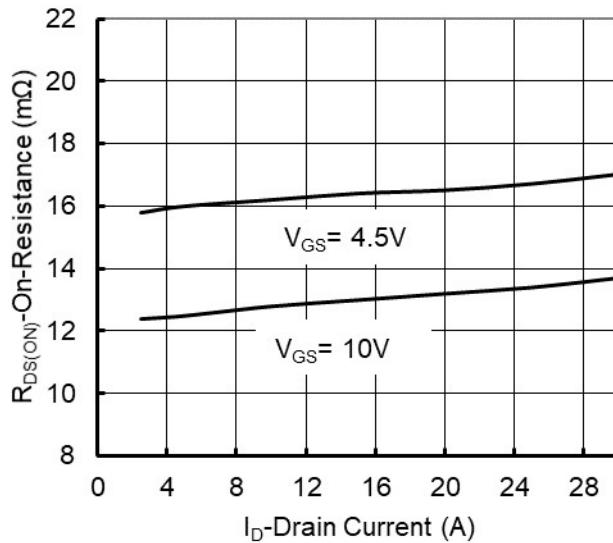
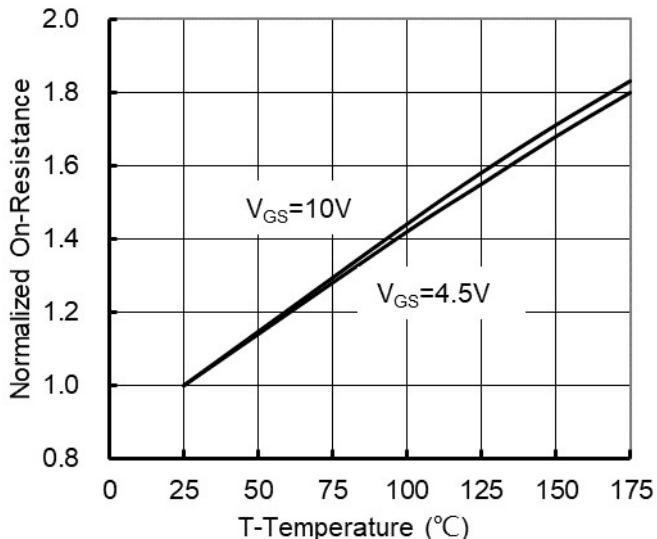
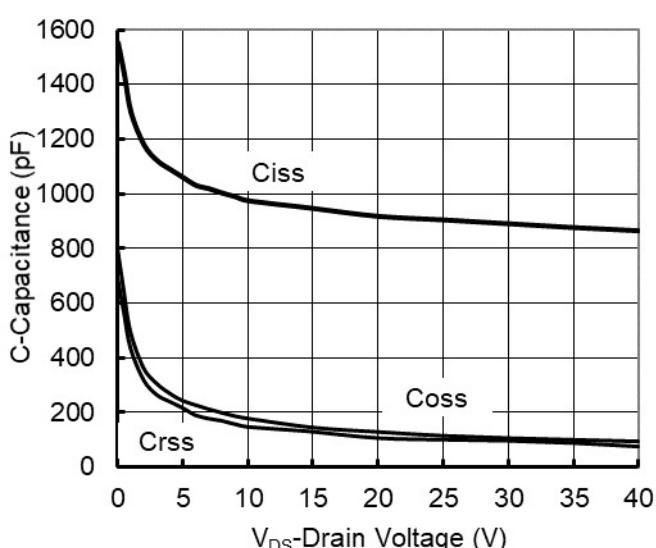
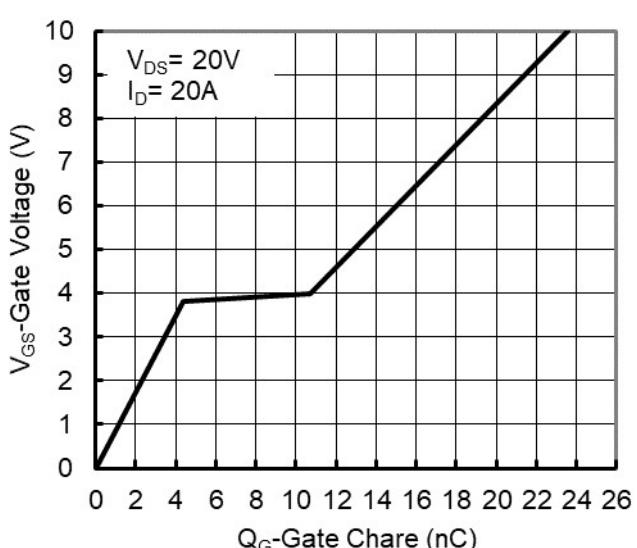
YJQ20N04A

■ Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}= \pm 20\text{V}, V_{\text{DS}}=0\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.0	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}= 10\text{V}, I_{\text{D}}=20\text{A}$		11	14	$\text{m}\Omega$
		$V_{\text{GS}}= 4.5\text{V}, I_{\text{D}}=10\text{A}$		14.3	18.5	
Diode Forward Voltage	V_{SD}	$I_{\text{S}}=10\text{A}, V_{\text{GS}}=0\text{V}$		0.7	1.2	V
Maximum Body-Diode Continuous Current	I_{S}				20	A
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$		917		pF
Output Capacitance	C_{oss}			128		
Reverse Transfer Capacitance	C_{rss}			108		
Switching Parameters						
Total Gate Charge	Q_{g}	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=20\text{V}, I_{\text{D}}=20\text{A}$		23.6		nC
Gate-Source Charge	Q_{gs}			4.4		
Gate-Drain Charge	Q_{gd}			6.3		
Reverse Recovery Charge	Q_{rr}	$I_{\text{F}}=20\text{A}, \text{di}/\text{dt}=100\text{A}/\text{us}$		0.4		ns
Reverse Recovery Time	t_{rr}			7		
Turn-on Delay Time	$t_{\text{D}(\text{on})}$	$V_{\text{GS}}=10\text{V}, V_{\text{DD}}=20\text{V}, I_{\text{D}}=2\text{A}, R_{\text{GEN}}=3\Omega$		10		ns
Turn-on Rise Time	t_{r}			56		
Turn-off Delay Time	$t_{\text{D}(\text{off})}$			27		
Turn-off fall Time	t_{f}			72		

A. Pulse Test: Pulse Width $\leq 300\text{us}$, Duty cycle $\leq 2\%$.

B. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta UC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

**■ Typical Performance Characteristics****Figure 1. Output Characteristics****Figure 2. Transfer Characteristics****Figure 3. On-Resistance vs. Drain Current and Gate Voltage****Figure 4. On-Resistance vs. Junction Temperature****Figure 5. Capacitance Characteristics****Figure 6. Gate Charge**

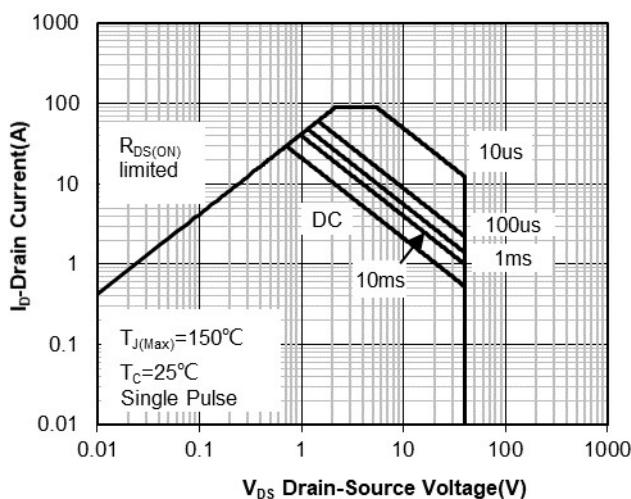


Figure 7. Safe Operation Area

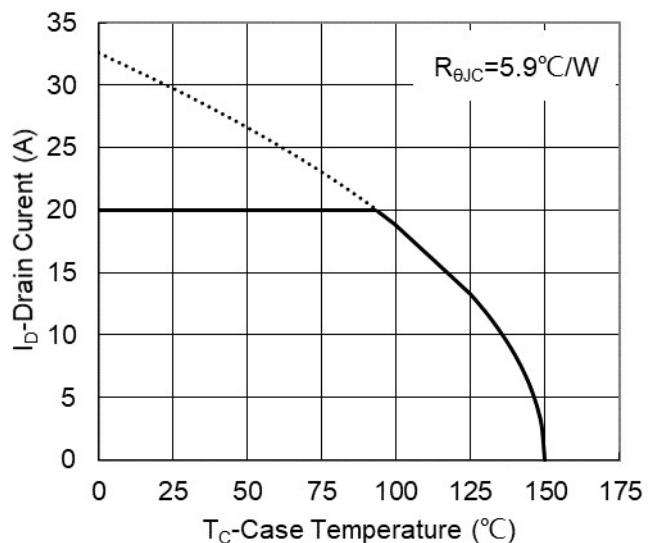


Figure 8. Maximum Continuous Drain Current vs Case Temperature

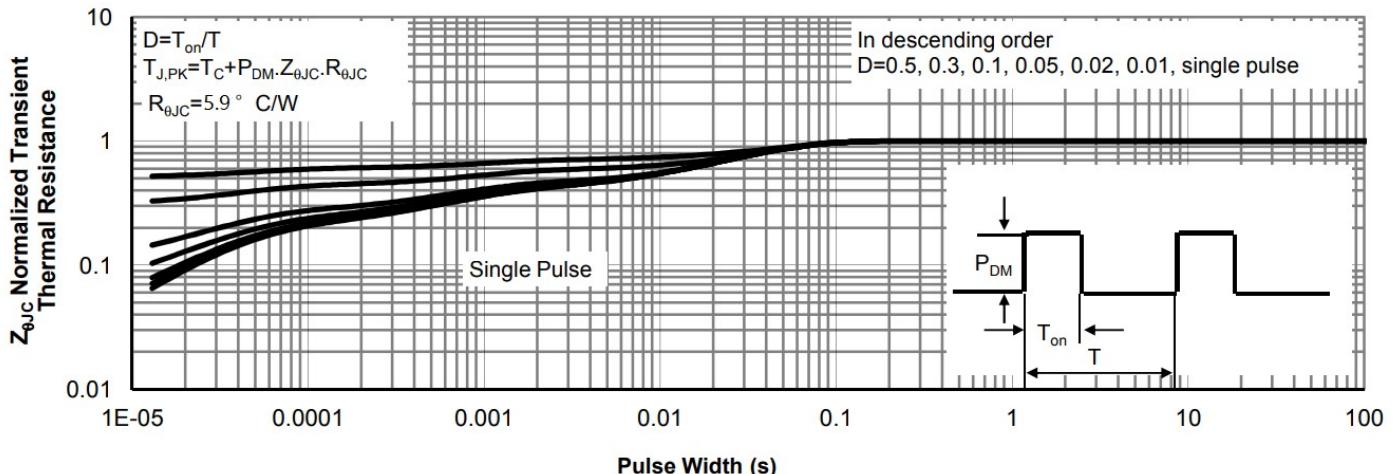
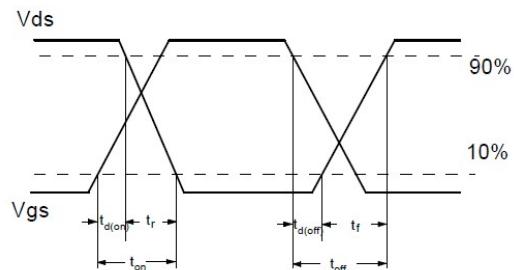
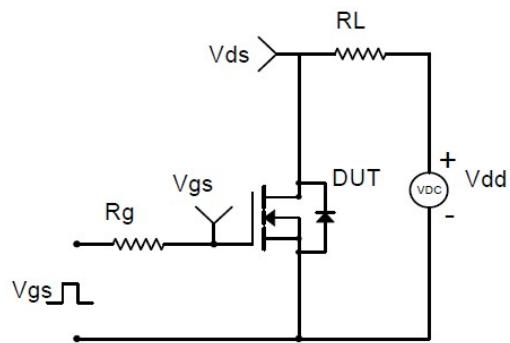
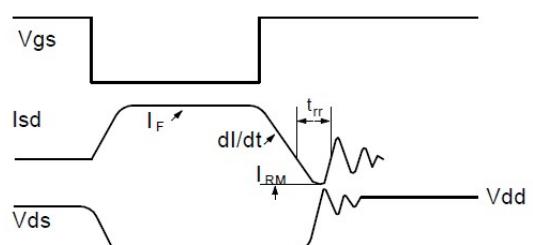
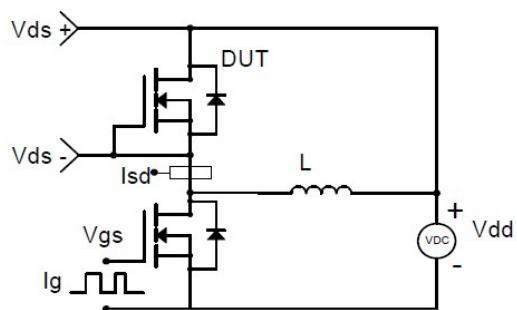


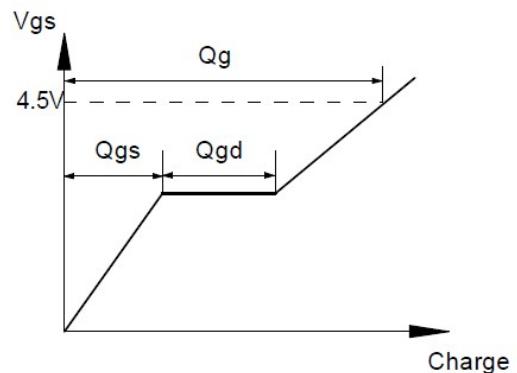
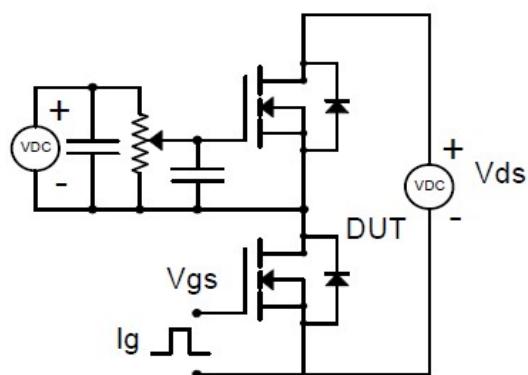
Figure 9. Normalized Maximum Transient Thermal Impedance



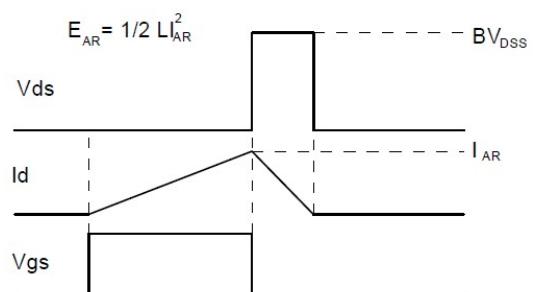
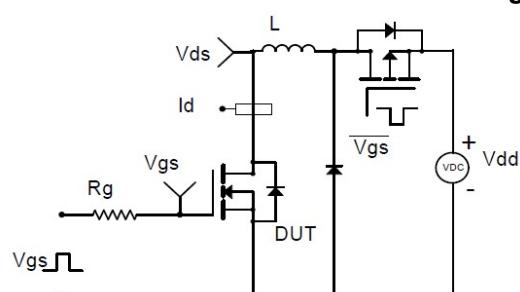
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



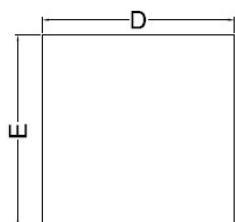
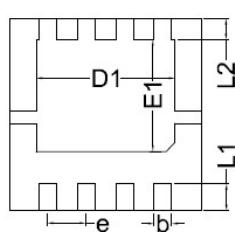
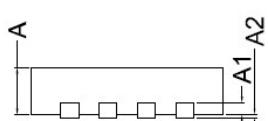
Gate Charge Test Circuit & Waveform



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



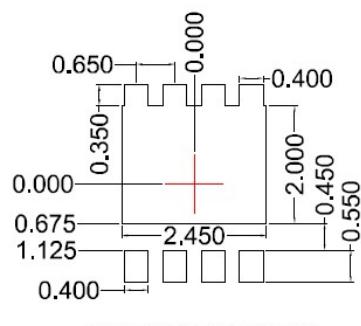
■ DFN3.3X3.3 Package information

Top View
正面视图Bottom View
背面视图Side View
侧面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.15	3.25	3.35
E	3.15	3.25	3.35
A	0.70	0.80	0.90
A1		0.20 BSC	
A2			0.10
D1	2.20	2.35	2.50
E1	1.80	1.90	2.00
L1	0.35	0.45	0.55
L2		0.35 BSC	
b	0.20	0.30	0.40
e		0.65 BSC	

Note:

1. Controlling dimension:in millimeters.
2. General tolerance: $\pm 0.10\text{mm}$.
3. The pad layout is for reference purposes only.

Suggested Solder Pad Layout
Top View



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